

P-Channel Power MOSFET

-20V, -6.5A, 26mΩ

FEATURES

- Fast switching
- Suitable for -1.8V Gate Drive Applications
- Pb-free plating
- RoHS compliant
- Halogen-free mold compound

KEY PERFORMANCE PARAMETERS				
PARAMETER		VALUE	UNIT	
V _{DS}		-20	V	
I_D		-6.5	Α	
R _{DS(on)} (max)	V _{GS} = -4.5V	26		
	$V_{GS} = -2.5V$	32	mΩ	
	$V_{GS} = -1.8V$	40		
Q_{g}		19.5	nC	





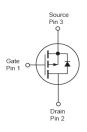


APPLICATION

- Battery Pack
- Portable Devices







Notes: Moisture sensitivity level: level 3. Per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	-20	V	
Gate-Source Voltage		V_{GS}	±10	V	
Continuous Drain Current	$T_C = 25^{\circ}C$		-6.5		
	T _C = 100°C	I _D	-4.1	A	
Pulsed Drain Current (Note 1)		I _{DM}	-26	А	
Total Power Dissipation	$T_C = 25^{\circ}C$	P _{DTOT}	1.56	W	
Operating Junction Temperature		TJ	150	°C	
Operating Junction and Storage Temperature Range		T _J , T _{STG}	- 55 to +150	°C	

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction to Ambient Thermal Resistance	R _{eJA}	80	°C/W	

Notes: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ is shown for single device operation on FR-4 PCB in still air.



ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static (Note 2)						_
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = -250\mu A$	BV _{DSS}	-20			V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	$V_{GS(TH)}$	-0.3	-0.6	-1.0	V
Gate Body Leakage	$V_{GS} = \pm 10V, V_{DS} = 0V$	I _{GSS}			±100	nA
Zara Cata Valtaria Brain Current	$V_{DS} = -20V, V_{GS} = 0V$				-1	μА
Zero Gate Voltage Drain Current	$V_{DS} = -16V, T_J = 125^{\circ}C$	I _{DSS}			-10	
	$V_{GS} = -4.5V, I_D = -5A$			21	26	mΩ
Drain-Source On-State Resistance	$V_{GS} = -2.5V, I_D = -4A$	$R_{DS(on)}$		26	32	
	$V_{GS} = -1.8V, I_D = -3A$			32	40	
Forward Transconductance	$V_{DS} = -10V, I_{S} = -5A$	g _{fs}		15		S
Dynamic (Note 3)						
Total Gate Charge		Q_g		19.5		nC
Gate-Source Charge	$V_{DS} = -10V, I_D = -5A,$ $V_{GS} = -4.5V$	Q_{gs}		2		
Gate-Drain Charge		Q_gd		3.6		
Input Capacitance		C _{iss}		1670		
Output Capacitance	$V_{DS} = -15V, V_{GS} = 0V,$ F = 1.0MHz	C _{oss}		220		pF
Reverse Transfer Capacitance		C _{rss}		120		
Switching						
Turn-On Delay Time		t _{d(on)}		10.4		
Turn-On Rise Time	$V_{DD} = -10V, I_{D} = -1A,$ $V_{GS} = -4.5V, R_{GEN}$ $= 25\Omega$	t _r		37.5		
Turn-Off Delay Time		t _{d(off)}		89.1		ns
Turn-Off Fall Time	2312	t _f		24.6		
Source-Drain Diode						
Forward Voltage	$V_{GS} = 0V, I_{S} = -1A$	V_{SD}			-1	V
Continuous Forward Current	Integral reverse diode	I _S			-6.5	Α
Pulse Forward Current	in the MOSFET	I _{SM}			-26	Α

Notes:

- 1. Pulse width limited by safe operating area
- 2. Pulse test: PW ≤ 300µs, duty cycle ≤ 2%
- 3. Switching time is essentially independent of operating temperature.





ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM260P02CX RFG	SOT-23	3,000pcs / 7" Reel
TSM260P02CX6 RFG	SOT-26	3,000pcs / 7" Reel

Note:

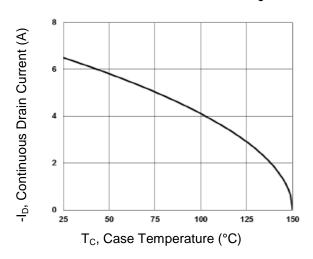
- 1. Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- 2. Halogen-free according to IEC 61249-2-21 definition



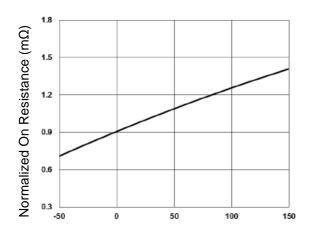
CHARACTERISTICS CURVES

(T_C = 25°C unless otherwise noted)

Continuous Drain Current vs. Tc

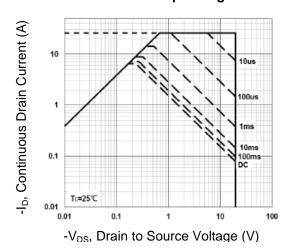


On-Resistance vs. Junction Temperature

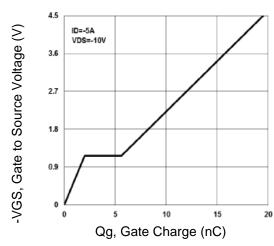


T_J, Junction Temperature (°C)

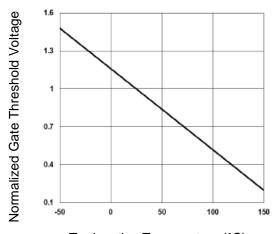
Maximum Safe Operating Area



Gate Charge

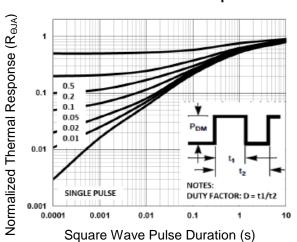


Threshold Voltage vs. Junction Temperature



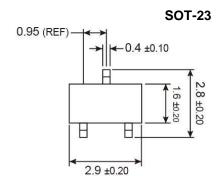
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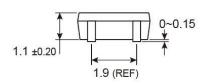
Normalized Thermal Transient Impedance Curve

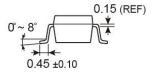




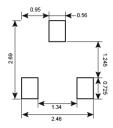
PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)







SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM



26 = Device Code

Y = Year Code

M = Month Code for Halogen Free Product

 \mathbf{O} =Jan \mathbf{P} =Feb \mathbf{Q} =Mar \mathbf{R} =Apr

S =May T =Jun U =Jul V =Aug

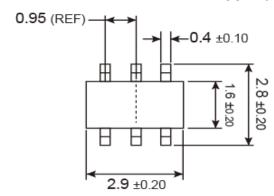
 $W = Sep \quad X = Oct \quad Y = Nov \quad Z = Dec$

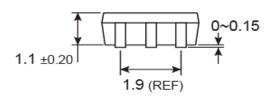
L = Lot Code

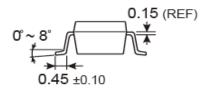


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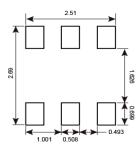
SOT-26







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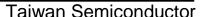
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L = Lot Code (1~9, A~Z)





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